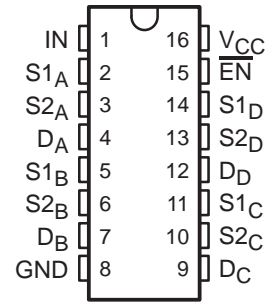
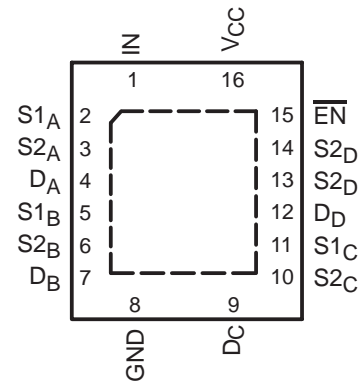


- Low Differential Gain and Phase ( $D_G = 0.64\%$ ,  $D_P = 0.1$  Degrees Typ)
- Wide Bandwidth (BW = 300 MHz Min)
- Low Crosstalk ( $X_{TALK} = -63$  dB Typ)
- Low Power Consumption ( $I_{CC} = 3 \mu A$  Max)
- Bidirectional Data Flow, With Near-Zero Propagation Delay
- Low ON-State Resistance ( $r_{on} = 3 \Omega$  Typ)
- $V_{CC}$  Operating Range From 4.5 V to 5.5 V
- $I_{off}$  Supports Partial-Power-Down Mode Operation
- Data and Control Inputs Provide Undershoot Clamp Diode
- Control Inputs Can Be Driven by TTL or 5-V/3.3-V CMOS Outputs
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Performance Tested Per JESD 22
  - 2000-V Human-Body Model (A114-B, Class II)
  - 1000-V Charged-Device Model (C101)
- Suitable for Both RGB and Composite-Video Switching

D, DBQ, OR PW PACKAGE  
(TOP VIEW)



RGY PACKAGE  
(TOP VIEW)



### description/ordering information

The TI TS5V330 video switch is a 4-bit 1-of-2 multiplexer/demultiplexer with a single switch-enable ( $\overline{EN}$ ) input. When  $\overline{EN}$  is low, the switch is enabled and the D port is connected to the S port. When  $\overline{EN}$  is high, the switch is disabled and the high-impedance state exists between the D and S ports. The select (IN) input controls the data path of the multiplexer/demultiplexer.

### ORDERING INFORMATION

$T_A$	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	QFN – RGY	Tape and reel	TS5V330RGYR	TE330
	SOIC – D	Tube	TS5V330D	TS5V330
		Tape and reel	TS5V330DR	
	SSOP (QSOP) – DBQ	Tape and reel	TS5V330DBQR	TE330
	TSSOP – PW	Tube	TS5V330PW	TE330
		Tape and reel	TS5V330PWR	

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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# TS5V330

## QUAD SPDT WIDE-BANDWIDTH VIDEO SWITCH WITH LOW ON-STATE RESISTANCE

SCDS164A – MAY 2004 – REVISED MAY 2004

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### description/ordering information (continued)

Low differential gain and phase make this switch ideal for composite and RGB video applications. This device has wide bandwidth and low crosstalk, making it suitable for high-frequency applications as well.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  feature ensures that damaging current will not backflow through the device when it is powered down. This switch maintains isolation during power off.

To ensure the high-impedance state during power up or power down,  $\overline{EN}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

FUNCTION TABLE

INPUTS		INPUT/OUTPUT D	FUNCTION
$\overline{EN}$	IN		
L	L	S1	D port = S1 port
L	H	S2	D port = S2 port
H	X	Z	Disconnect

PIN DESCRIPTIONS

PIN NAME	DESCRIPTION
S1, S2	Analog video I/Os
D	Analog video I/Os
IN	Select input
$\overline{EN}$	Switch-enable input

**TS5V330**  
**QUAD SPDT WIDE-BANDWIDTH VIDEO SWITCH**  
**WITH LOW ON-STATE RESISTANCE**

SCDS164A – MAY 2004 – REVISED MAY 2004

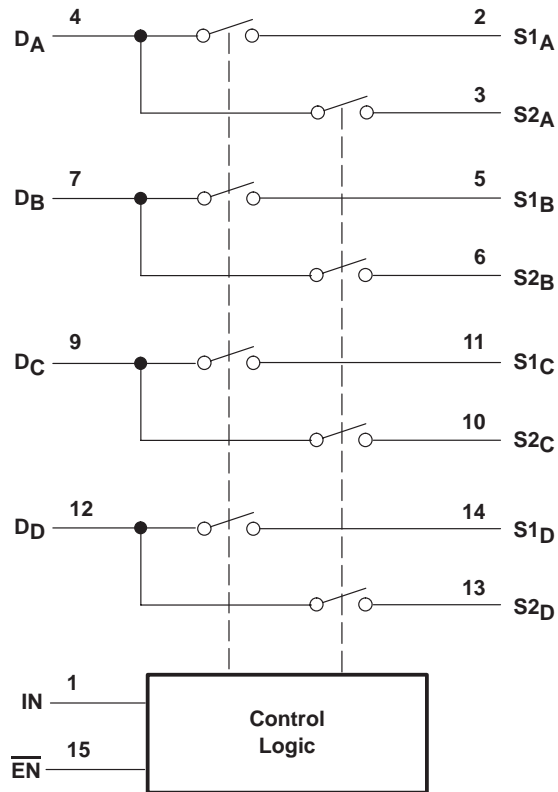
**PARAMETER DEFINITIONS**

PARAMETER	DESCRIPTION
$r_{on}$	Resistance between the D and S ports, with the switch in the ON state
$I_{OZ}$	Output leakage current measured at the D and S ports, with the switch in the OFF state
$I_{OS}$	Short-circuit current measured at the I/O pins
$V_{IN}$	Voltage at the IN pin
$V_{EN}$	Voltage at the $\overline{EN}$ pin
$C_{IN}$	Capacitance at the control ( $\overline{EN}$ , IN) inputs
$C_{OFF}$	Capacitance at the analog I/O port when the switch is OFF
$C_{ON}$	Capacitance at the analog I/O port when the switch is ON
$V_{IH}$	Minimum input voltage for logic high for the control ( $\overline{EN}$ , IN) inputs
$V_{IL}$	Minimum input voltage for logic low for the control ( $\overline{EN}$ , IN) inputs
$V_{hys}$	Hysteresis voltage at the control ( $\overline{EN}$ , IN) inputs
$V_{IK}$	I/O and control ( $\overline{EN}$ , IN) inputs diode clamp voltage
$V_I$	Voltage applied to the D or S pins when D or S is the switch input
$V_O$	Voltage applied to the D or S pins when D or S is the switch output
$I_{IH}$	Input high leakage current of the control ( $\overline{EN}$ , IN) inputs
$I_{IL}$	Input low leakage current of the control ( $\overline{EN}$ , IN) inputs
$I_I$	Current into the D or S pins when D or S is the switch input
$I_O$	Current into the D or S pins when D or S is the switch output
$I_{off}$	Output leakage current measured at the D or S ports, with $V_{CC} = 0$
$t_{ON}$	Propagation delay measured between 50% of the digital input to 90% of the analog output when switch is turned ON
$t_{OFF}$	Propagation delay measured between 50% of the digital input to 90% of the analog output when switch is turned OFF
BW	Frequency response of the switch in the ON state measured at $-3$ dB
$X_{TALK}$	Unwanted signal coupled from channel to channel. Measured in $-dB$ . $X_{TALK} = 20 \log V_O/V_I$ . This is a nonadjacent crosstalk.
$O_{IRR}$	Off isolation is the resistance (measured in $-dB$ ) between the input and output with the switch OFF.
$D_G$	Magnitude variation between analog input and output pins when the switch is ON and the dc offset of composite-video signal varies at the analog input pin. In the NTSC standard, the frequency of the video signal is 3.58 MHz, and dc offset is from 0 to 0.714 V.
$D_P$	Phase variation between analog input and output pins when the switch is ON and the dc offset of composite-video signal varies at the analog input pin. In the NTSC standard, the frequency of the video signal is 3.58 MHz, and dc offset is from 0 to 0.714 V.
$I_{CC}$	Static power-supply current
$I_{CCD}$	Variation of $I_{CC}$ for a change in frequency in the control ( $\overline{EN}$ , IN) inputs
$\Delta I_{CC}$	This is the increase in supply current for each control input that is at the specified voltage level, rather than $V_{CC}$ or GND.

# TS5V330 QUAD SPDT WIDE-BANDWIDTH VIDEO SWITCH WITH LOW ON-STATE RESISTANCE

SCDS164A – MAY 2004 – REVISED MAY 2004

functional diagram (positive logic)



# TS5V330

## QUAD SPDT WIDE-BANDWIDTH VIDEO SWITCH WITH LOW ON-STATE RESISTANCE

SCDS164A – MAY 2004 – REVISED MAY 2004

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$ .....	–0.5 V to 7 V
Control input voltage range, $V_{IN}$ (see Notes 1 and 2) .....	–0.5 V to 7 V
Switch I/O voltage range, $V_{I/O}$ (see Notes 1, 2, and 3) .....	–0.5 V to 7 V
Control input clamp current, $I_{IK}$ ( $V_{IN} < 0$ ) .....	–50 mA
I/O port clamp current, $I_{I/OK}$ ( $V_{I/O} < 0$ ) .....	–50 mA
ON-state switch current, $I_{I/O}$ (see Note 4) .....	±128 mA
Continuous current through $V_{CC}$ or GND terminals .....	±100 mA
Package thermal impedance, $\theta_{JA}$ (see Note 5): D package .....	73°C/W
(see Note 5): DBQ package .....	90°C/W
(see Note 5): PW package .....	108°C/W
(see Note 6): RGY package .....	39°C/W
Storage temperature range, $T_{stg}$ .....	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltages are with respect to ground, unless otherwise specified.
  2. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
  3.  $V_I$  and  $V_O$  are used to denote specific conditions for  $V_{I/O}$ .
  4.  $I_I$  and  $I_O$  are used to denote specific conditions for  $I_{I/O}$ .
  5. The package thermal impedance is calculated in accordance with JESD 51-7.
  6. The package thermal impedance is calculated in accordance with JESD 51-5.

### recommended operating conditions (see Note 7)

		MIN	MAX	UNIT
$V_{CC}$	Supply voltage	4	5.5	V
$V_{IH}$	High-level control input voltage ( $\overline{EN}$ , IN)	2	5.5	V
$V_{IL}$	Low-level control input voltage ( $\overline{EN}$ , IN)	0	0.8	V
$V_{ANALOG}$	Analog I/O voltage	0	2	V
$T_A$	Operating free-air temperature	–40	85	°C

NOTE 7: All unused control inputs of the device must be held at  $V_{CC}$  or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



# TS5V330

## QUAD SPDT WIDE-BANDWIDTH VIDEO SWITCH WITH LOW ON-STATE RESISTANCE

SCDS164A – MAY 2004 – REVISED MAY 2004

electrical characteristics over recommended operating free-air temperature range,  $V_{CC} = 5\text{ V} \pm 10\%$  (unless otherwise noted)

PARAMETER		TEST CONDITIONS			MIN	TYP†	MAX	UNIT
$V_{IK}$	$\overline{EN}, IN$	$V_{CC} = 4.5\text{ V}$ ,	$I_{IN} = -18\text{ mA}$				-1.8	V
$V_{hys}$	$\overline{EN}, IN$				150			mV
$I_{IH}$	$\overline{EN}, IN$	$V_{CC} = 5.5\text{ V}$ ,	$V_{IN}$ and $V_{EN} = V_{CC}$				$\pm 1$	$\mu\text{A}$
$I_{IL}$	$\overline{EN}, IN$	$V_{CC} = 5.5\text{ V}$ ,	$V_{IN}$ and $V_{EN} = \text{GND}$				$\pm 1$	$\mu\text{A}$
$I_{OZ}^{\ddagger}$		$V_{CC} = 5.5\text{ V}$ ,	$V_O = 0$ to $5.5\text{ V}$ , $V_I = 0$ ,	Switch OFF			$\pm 1$	$\mu\text{A}$
$I_{OS}^{\S}$		$V_{CC} = 5.5\text{ V}$ ,	$V_O = 0.5 V_{CC}$ , $V_I = 0$ ,	Switch ON	50			mA
$I_{off}$		$V_{CC} = 0$ ,	$V_O = 0$ to $5.5\text{ V}$ ,	$V_I = 0$			1	$\mu\text{A}$
$I_{CC}$		$V_{CC} = 5.5\text{ V}$ ,	$I_{I/O} = 0$ ,	Switch ON or OFF			3	$\mu\text{A}$
$\Delta I_{CC}$	$\overline{EN}, IN$	$V_{CC} = 5.5\text{ V}$ ,	One input at $3.4\text{ V}$ ,	Other inputs at $V_{CC}$ or GND			2.5	mA
$I_{CCD}$		$V_{CC} = 5.5\text{ V}$ , $V_{EN} = \text{GND}$ ,	D and S ports open,	$V_{IN}$ input switching 50% duty cycle			0.25	mA/ MHz
$C_{IN}$	$\overline{EN}, IN$	$V_{IN}$ or $V_{EN} = 0$ ,	$f = 1\text{ MHz}$				3.5	pF
$C_{OFF}$	D port	$V_I = 0$ ,	$f = 1\text{ MHz}$ , Outputs open	Switch OFF			6	pF
	S port						4	
$C_{ON}$		$V_I = 0$ ,	$f = 1\text{ MHz}$ , Outputs open	Switch ON			14	pF
$r_{on}^{\parallel}$		$V_{CC} = 4.5\text{ V}$	$V_I = 1\text{ V}$ ,	$I_O = 13\text{ mA}$ ,	$R_L = 75\ \Omega$		3	$\Omega$
			$V_I = 2\text{ V}$ ,	$I_O = 26\text{ mA}$ ,	$R_L = 75\ \Omega$		7	

$V_I$ ,  $V_O$ ,  $I_I$ , and  $I_O$  refer to I/O pins.

† All typical values are at  $V_{CC} = 5\text{ V}$  (unless otherwise noted),  $T_A = 25^\circ\text{C}$ .

‡ For I/O ports,  $I_{OZ}$  includes the input leakage current.

§ The  $I_{OS}$  test is applicable to only one ON channel at a time. The duration of this test is less than one second.

¶ Measured by the voltage drop between the D and S terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (D or S) terminals.

switching characteristics over recommended operating free-air temperature range,  $V_{CC} = 5\text{ V} \pm 10\%$ ,  $R_L = 75\ \Omega$ ,  $C_L = 20\text{ pF}$  (unless otherwise noted) (see Figure 5)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	TYP	MAX	UNIT
$t_{ON}$	S	D		2.5	6	ns
$t_{OFF}$	S	D		1.1	6	ns

dynamic characteristics over recommended operating free-air temperature range,  $V_{CC} = 5\text{ V} \pm 10\%$  (unless otherwise noted)

PARAMETER	TEST CONDITIONS			MIN	TYP†	MAX	UNIT
$D_G^{\#}$	$R_L = 150\ \Omega$ ,	$f = 3.58\text{ MHz}$ , see Figure 6			0.64		%
$D_p^{\#}$	$R_L = 150\ \Omega$ ,	$f = 3.58\text{ MHz}$ , see Figure 6			0.1		Deg
BW	$R_L = 150\ \Omega$ , see Figure 7			300			MHz
$X_{TALK}$	$R_L = 150\ \Omega$ ,	$f = 10\text{ MHz}$ ,	$R_{IN} = 10\ \Omega$ , see Figure 8		-63		dB
$O_{IRR}$	$R_L = 150\ \Omega$ ,	$f = 10\text{ MHz}$ , see Figure 9			-60		dB

† All typical values are at  $V_{CC} = 5\text{ V}$  (unless otherwise noted),  $T_A = 25^\circ\text{C}$ .

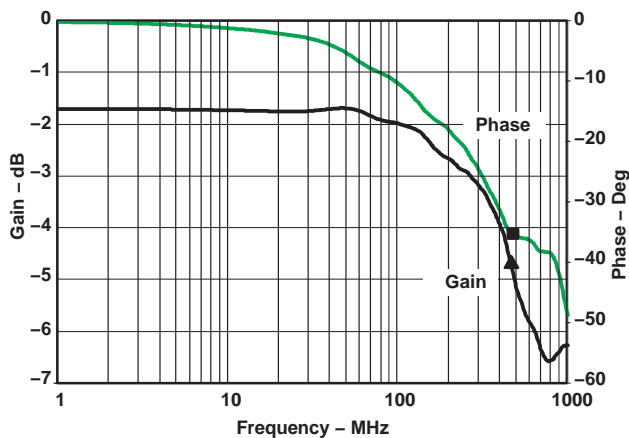
#  $D_G$  and  $D_p$  are expressed in absolute magnitude.



# TS5V330 QUAD SPDT WIDE-BANDWIDTH VIDEO SWITCH WITH LOW ON-STATE RESISTANCE

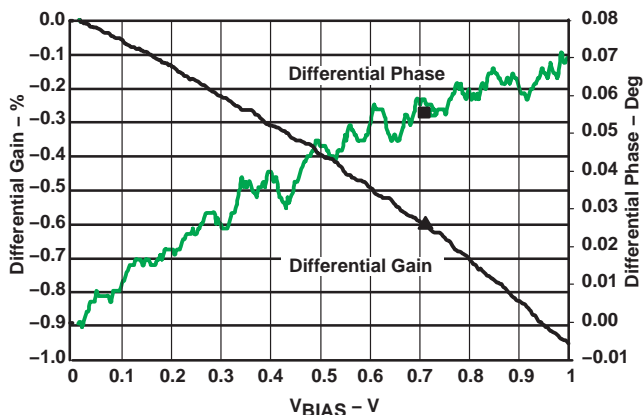
SCDS164A – MAY 2004 – REVISED MAY 2004

## OPERATING CHARACTERISTICS



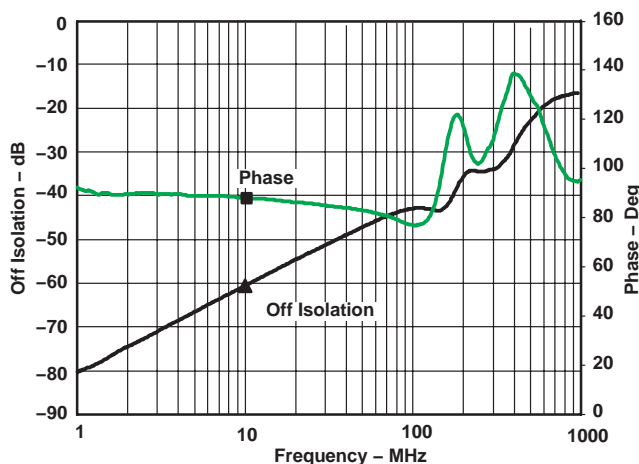
- Phase at -3-dB Frequency, 35 Degrees
- ▲ Gain -3 dB at 460 MHz

**Figure 1. Gain/Phase vs Frequency**



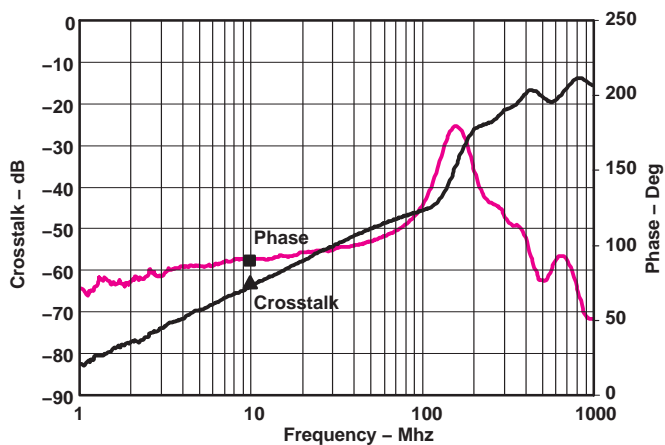
- Differential Phase at 0.714, 0.056 Degree
- ▲ Differential Gain at 0.714, -0.63%

**Figure 2. Differential Gain/Phase vs VBIAS**



- Phase at 10 MHz, 88.5 Degrees
- ▲ Off Isolation at 10 MHz, -60 dB

**Figure 3. Off Isolation vs Frequency**



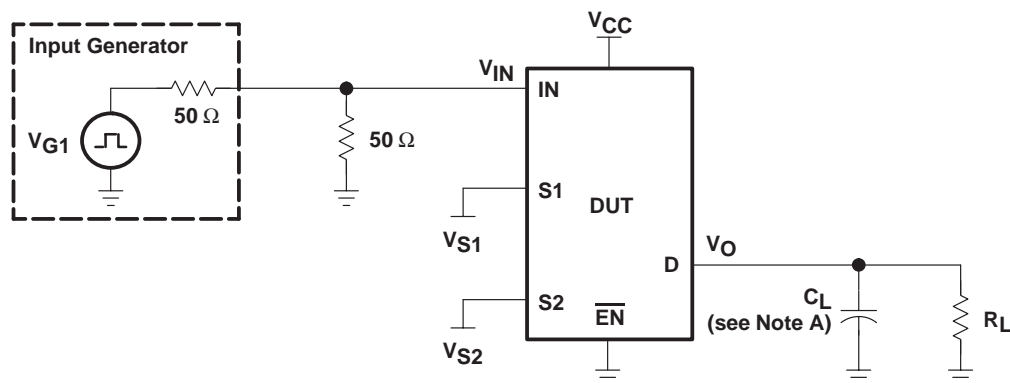
- Phase at 10 MHz, -90.4 Degrees
- ▲ Crosstalk at 10 MHz, -63.9 dB

**Figure 4. Crosstalk vs Frequency**

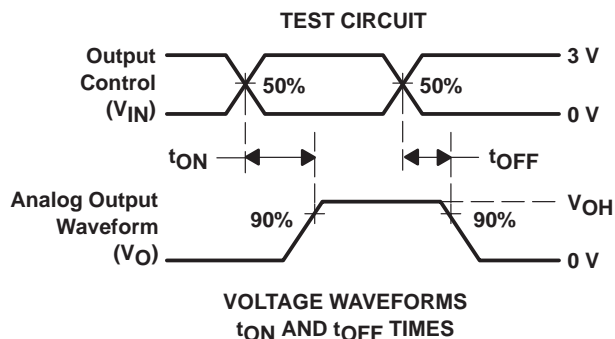
**TS5V330**  
**QUAD SPDT WIDE-BANDWIDTH VIDEO SWITCH**  
**WITH LOW ON-STATE RESISTANCE**

SCDS164A – MAY 2004 – REVISED MAY 2004

**PARAMETER MEASUREMENT INFORMATION**



TEST	VCC	RL	CL	VS1	VS2
tON	5 V ± 0.5 V	75	20	GND	3 V
	5 V ± 0.5 V	75	20	3 V	GND
tOFF	5 V ± 0.5 V	75	20	GND	3 V
	5 V ± 0.5 V	75	20	3 V	GND

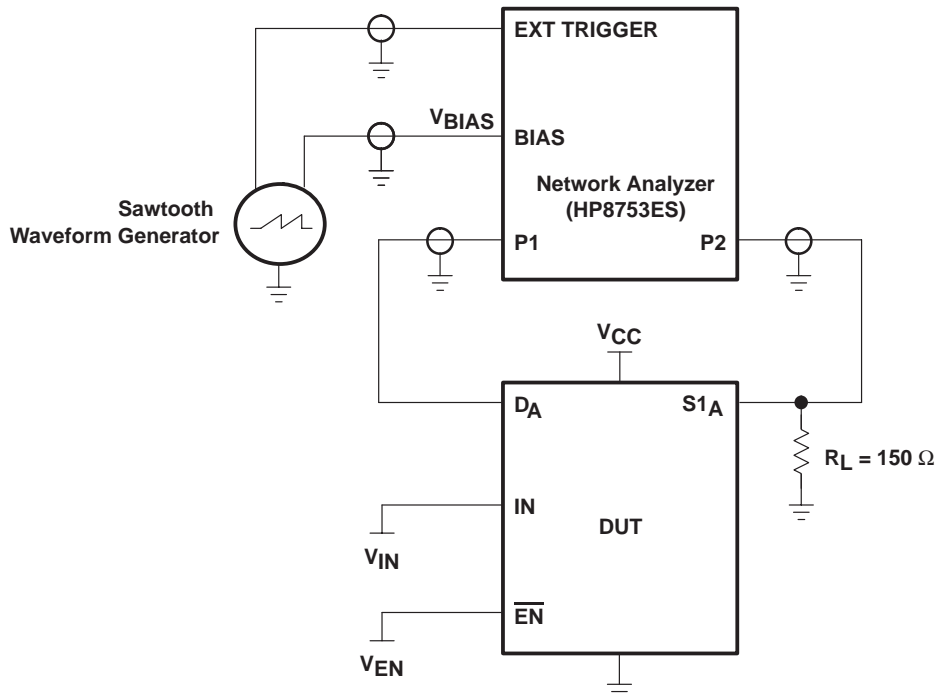


- NOTES: A. CL includes probe and jig capacitance.  
 B. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, ZO = 50 Ω, tr ≤ 2.5 ns, tf ≤ 2.5 ns.  
 C. The outputs are measured one at a time, with one transition per measurement.

**Figure 5. Test Circuit and Voltage Waveforms**



**PARAMETER MEASUREMENT INFORMATION**



NOTE A: For additional information on measurement method, refer to the TI application report, *Measuring Differential Gain and Phase*, literature number SLOA040.

**Figure 6. Test Circuit for Differential Gain/Phase Measurement**

Differential gain and phase are measured at the output of the ON channel. For example, when  $V_{IN} = 0$ ,  $V_{EN} = 0$ , and  $D_A$  is the input, the output is measured at  $S1_A$ .

**HP8753ES setup**

Average = 20  
 RBW = 300 Hz  
 ST = 1.381 s  
 P1 = -7 dBm  
 CW frequency = 3.58 MHz

**sawtooth waveform generator setup**

$V_{BIAS} = 0$  to 1 V  
 Frequency = 0.905 Hz

# TS5V330 QUAD SPDT WIDE-BANDWIDTH VIDEO SWITCH WITH LOW ON-STATE RESISTANCE

SCDS164A – MAY 2004 – REVISED MAY 2004

## PARAMETER MEASUREMENT INFORMATION

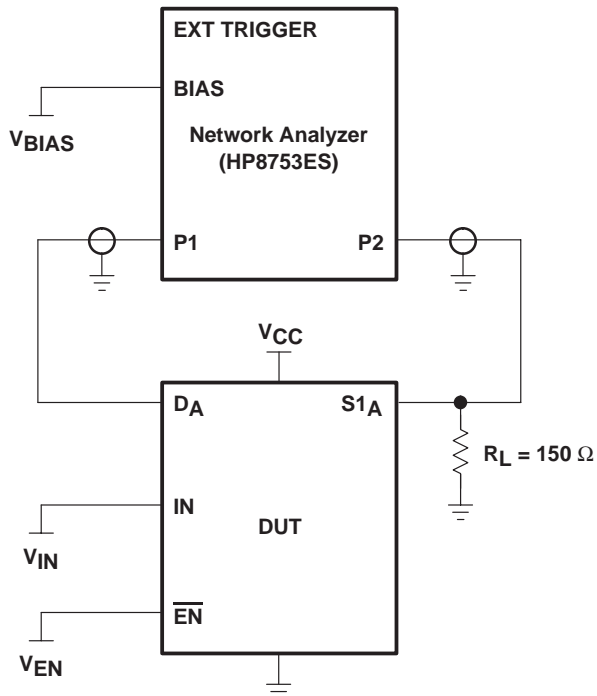


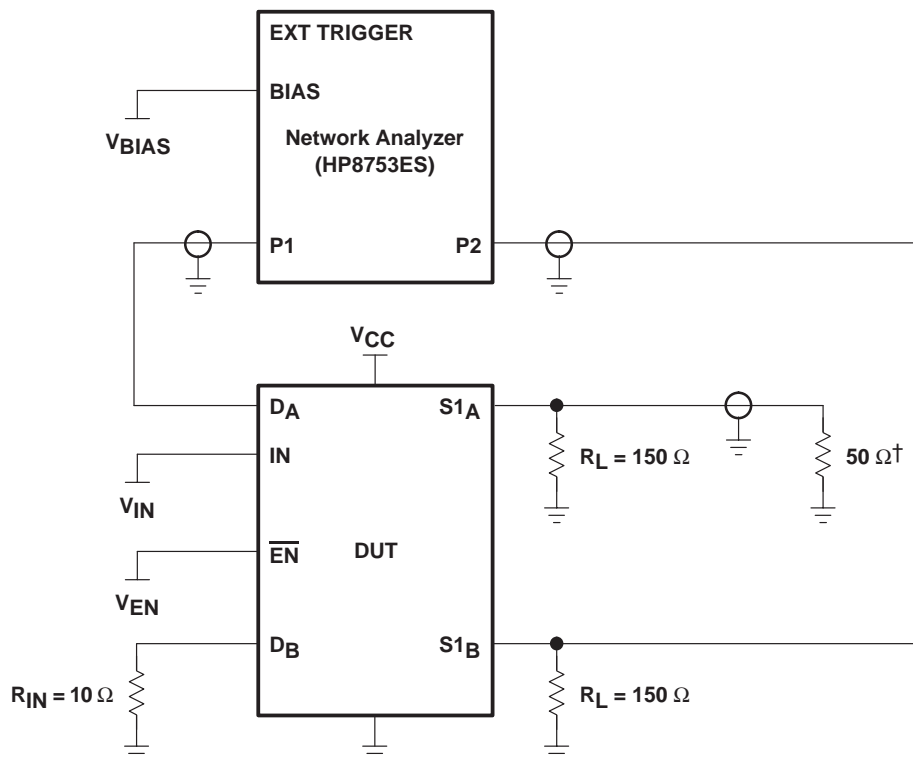
Figure 7. Test Circuit for Frequency Response (BW)

Frequency response is measured at the output of the ON channel. For example, when  $V_{IN} = 0$ ,  $V_{EN} = 0$ , and  $D_A$  is the input, the output is measured at  $S1_A$ . All unused analog I/O ports are left open.

### HP8753ES setup

Average = 4  
RBW = 3 kHz  
 $V_{BIAS} = 0.35$  V  
ST = 2 s  
P1 = 0 dBm

**PARAMETER MEASUREMENT INFORMATION**



† A 50-Ω termination resistor is needed for the network analyzer.

**Figure 8. Test Circuit for Crosstalk ( $X_{TALK}$ )**

Crosstalk is measured at the output of the nonadjacent ON channel. For example, when  $V_{IN} = 0$ ,  $V_{EN} = 0$ , and  $D_A$  is the input, the output is measured at  $S_{1B}$ . All unused analog input (D) ports and output (S) ports are connected to GND through 10-Ω and 50-Ω pulldown resistors, respectively.

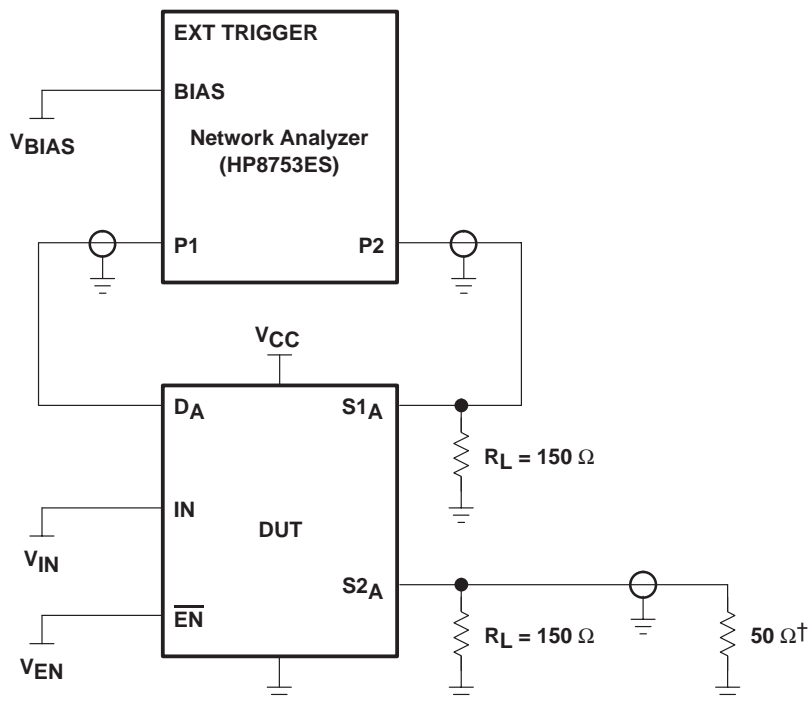
**HP8753ES setup**

- Average = 4
- RBW = 3 kHz
- $V_{BIAS} = 0.35$  V
- ST = 2 s
- P1 = 0 dBm

**TS5V330**  
**QUAD SPDT WIDE-BANDWIDTH VIDEO SWITCH**  
**WITH LOW ON-STATE RESISTANCE**

SCDS164A – MAY 2004 – REVISED MAY 2004

**PARAMETER MEASUREMENT INFORMATION**



† A 50-Ω termination resistor is needed for the network analyzer.

**Figure 9. Test Circuit for Off Isolation ( $O_{IRR}$ )**

Off-isolation is measured at the output of the OFF channel. For example, when  $V_{IN} = V_{CC}$ ,  $V_{EN} = 0$ , and  $D_A$  is the input, the output is measured at  $S1_A$ . All unused analog input (D) ports are left open, and output (S) ports are connected to GND through 50-Ω pulldown resistors.

**HP8753ES setup**

- Average = 4
- RBW = 3 kHz
- $V_{BIAS} = 0.35$  V
- ST = 2 s
- P1 = 0 dBm

D (R-PDSO-G16)

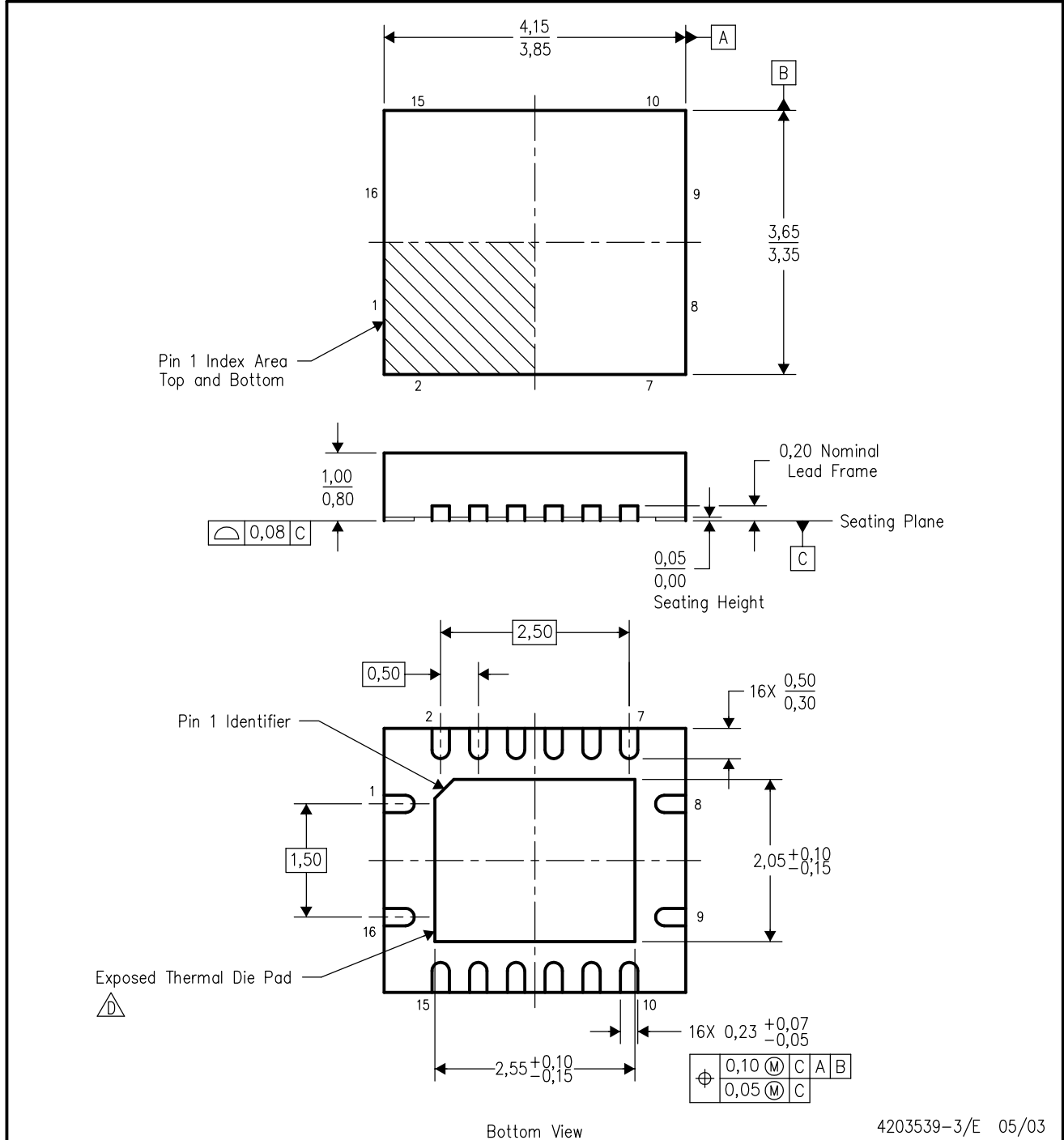
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
  - D. Falls within JEDEC MS-012 variation AC.

RGY (R-PQFP-N16)

PLASTIC QUAD FLATPACK



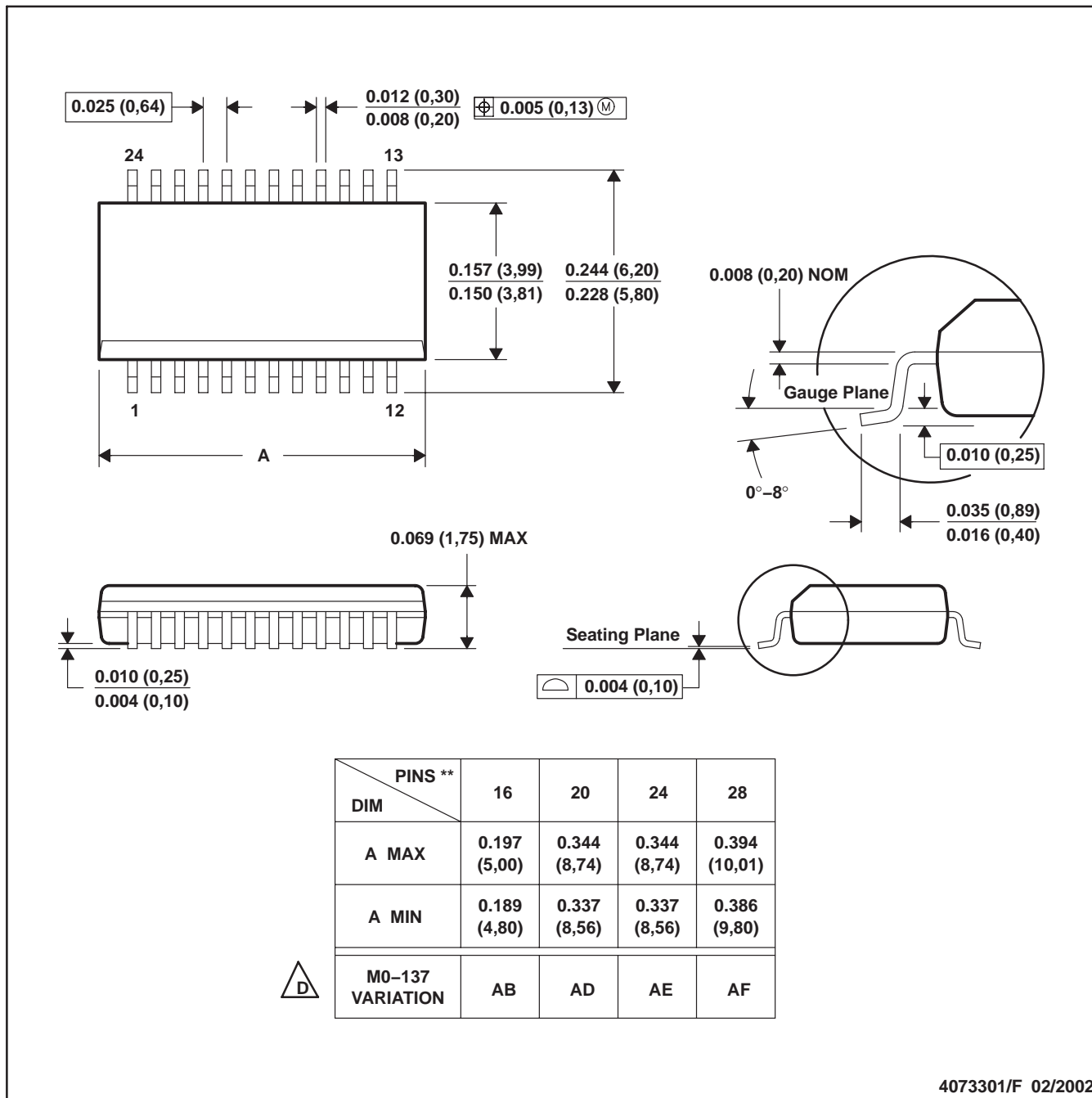
Bottom View

4203539-3/E 05/03

- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. QFN (Quad Flatpack No-Lead) package configuration.
  - The package thermal performance may be enhanced by bonding the thermal die pad to an external thermal plane. This pad is electrically and thermally connected to the backside of the die and possibly selected ground leads.
  - E. Package complies to JEDEC MO-241 variation BB.

DBQ (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE



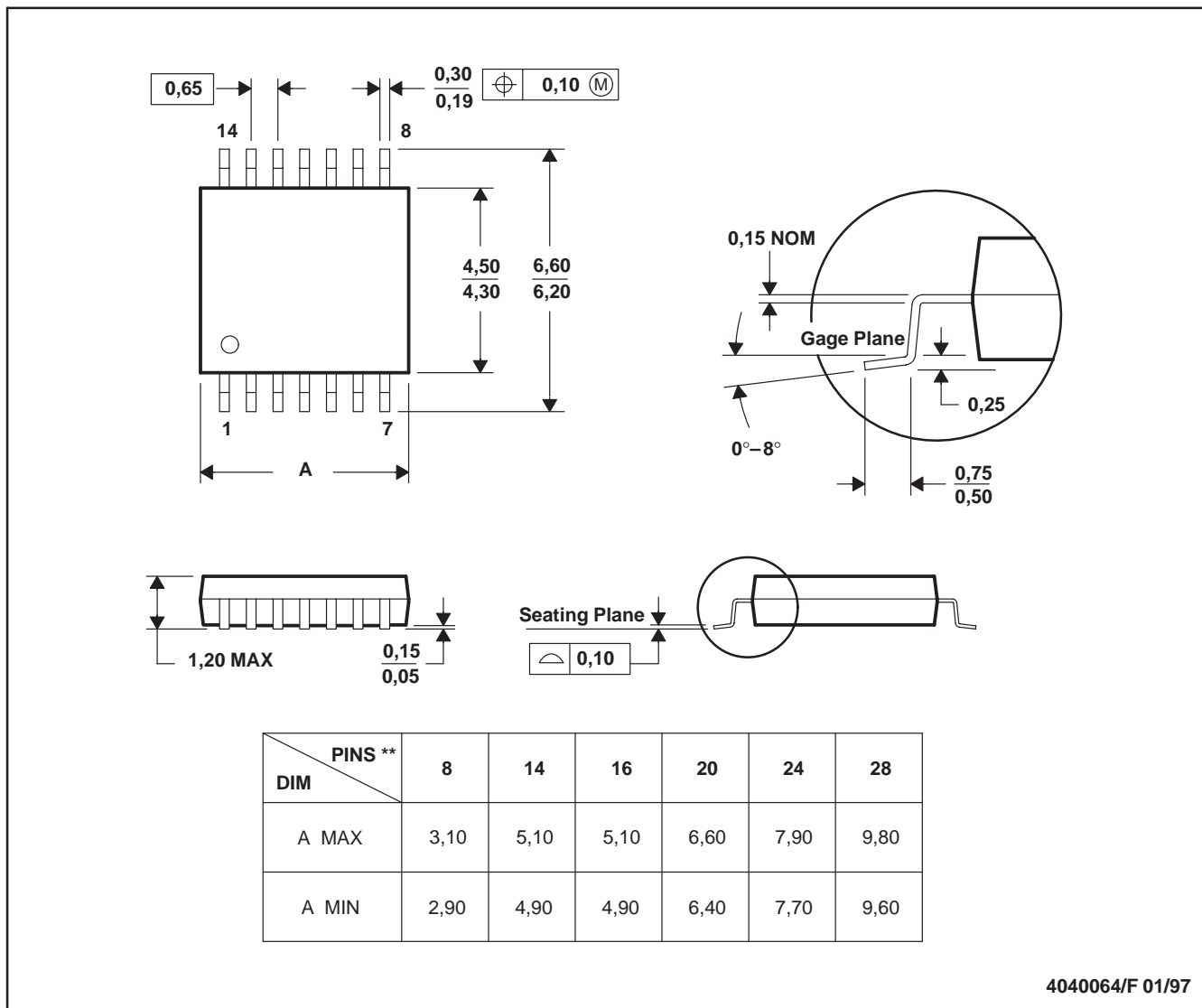
4073301/F 02/2002

- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MO-137.

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153



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Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>	Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>	Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
		Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
		Video & Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
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